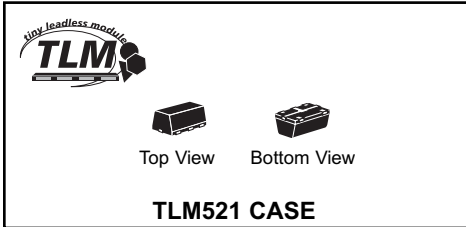


**CTLSH05-4M521**  
**SURFACE MOUNT**  
**LOW  $V_F$**   
**SILICON SCHOTTKY DIODE**



**MARKING CODE: CA**

# Central<sup>TM</sup>

## Semiconductor Corp.

**DESCRIPTION:**

The CENTRAL SEMICONDUCTOR CTLSH05-4M521 Low  $V_F$  Schottky Diode is a high quality Schottky Diode designed for applications where small size and operational efficiency are the prime requirements. With a maximum power dissipation of 0.9W, and a very small package footprint (comparable to the SOT-563), this leadless package design is capable of dissipating over 3 times the power of similar devices in comparable sized surface mount packages.

**FEATURES:**

- Very Small Package Size
- High Thermal Efficiency
- Current ( $I_F=0.5A$ )
- Small TLM 2x1mm case
- Low Forward Voltage Drop
- ( $V_F=0.47V$  MAX @ 0.5A)

**APPLICATIONS:**

- DC/DC Converters
- Voltage Clamping
- Protection Circuits
- Battery Powered Portable Equipment

**MAXIMUM RATINGS:** ( $T_A=25^\circ C$ )

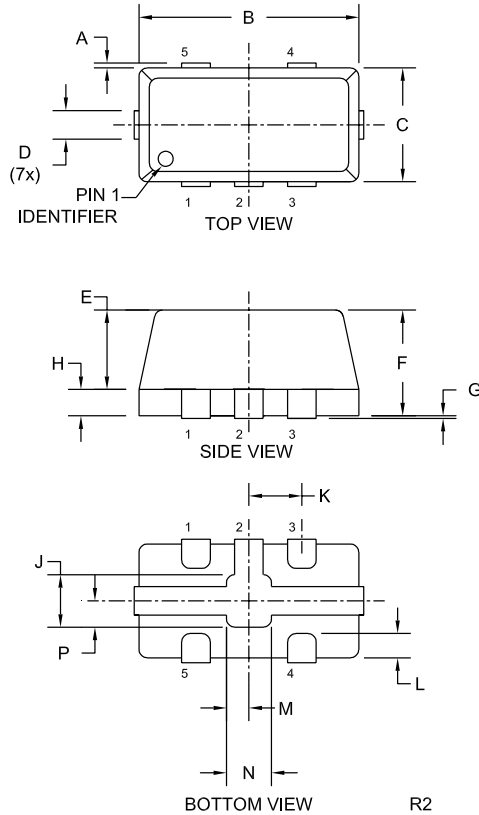
	<b>SYMBOL</b>	<b>UNITS</b>
Peak Repetitive Reverse Voltage	$V_{RRM}$	40 V
Continuous Forward Current	$I_F$	500 mA
Peak Repetitive Forward Current, $t_p \leq 1$ ms	$I_{FRM}$	3.5 A
Forward Surge Current, $t_p=8$ ms	$I_{FSM}$	10 A
Power Dissipation	$P_D$	0.9 W*
Operating and Storage		
Junction Temperature	$T_J, T_{stg}$	-65 to +150 $^\circ C$
Thermal Resistance	$\theta_{JA}$	139 $^\circ C/W^*$

**ELECTRICAL CHARACTERISTICS:** ( $T_A=25^\circ C$  unless otherwise noted)

<b>SYMBOL</b>	<b>TEST CONDITIONS</b>	<b>MIN</b>	<b>MAX</b>	<b>UNITS</b>
$I_R$	$V_R= 10V$		20	$\mu A$
$I_R$	$V_R= 30V$		100	$\mu A$
$BV_R$	$I_R= 500\mu A$	40		V
$V_F$	$I_F= 100\mu A$		0.13	V
$V_F$	$I_F= 1.0mA$		0.21	V
$V_F$	$I_F= 10mA$		0.27	V
$V_F$	$I_F= 100mA$		0.35	V
$V_F$	$I_F= 500mA$		0.47	V
$C_T$	$V_R=1.0V, f=1.0MHz$		50	pF

\*FR-4 Epoxy PCB with copper mounting pad area of 33mm<sup>2</sup>

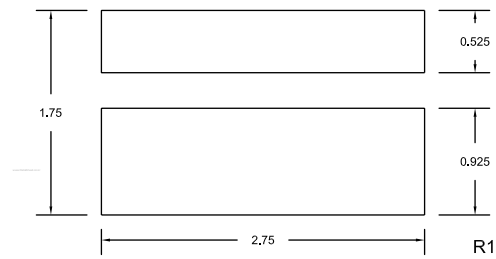
**TLM521 CASE - MECHANICAL OUTLINE**



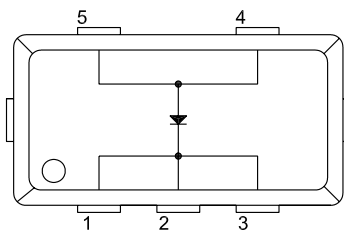
SYMBOL	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	—	0.005	—	0.125
B	0.075	0.083	1.900	2.100
C	0.035	0.043	0.900	1.100
D	0.007	0.012	0.170	0.300
E	0.026	0.030	0.650	0.750
F	0.031	0.039	0.800	1.000
G	0.000	0.002	0.000	0.050
H	0.006	0.010	0.150	0.250
J	0.013	0.021	0.330	0.530
K	0.020		0.500	
L	0.004	0.014	0.100	0.350
M	0.002	0.010	0.060	0.260
N	0.009	0.017	0.220	0.420
P	0.005	0.013	0.120	0.320

TLM521 (REV: R2)

Suggested mounting pad layout  
for maximum power dissipation  
(Dimensions in mm)



For standard mounting refer  
to TLM521 Package Details



**LEAD CODE:**

- 1) CATHODE
- 2) CATHODE
- 3) CATHODE
- 4) ANODE
- 5) ANODE

**MARKING CODE: CA**

R1 (27-April 2006)